





APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-35°C TO + 85°C (NOTE1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C	
	OPERATING HUMIDITY RANGE	40 % TO 80 % (NOTE2)	STORAGE HUMIDITY RANGE	40 % TO 70 % (NOTE3)	
	VOLTAGE	250V AC	APPLICABLE CONNECTOR	DF1-*S-2. 5C (#)	
	CURRENT	AWG 24 : 3 A AWG 26 : 2 A AWG 28 : 1 A	APPLICABLE CONTACT	DF1-2428SC (F)	
SPECIFICATIONS					
ITEM		TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING		CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100 mA(DC OR 1000HZ).	30 mΩ MAX.	X	—
INSULATION RESISTANCE		500 V DC.	1000 MΩ MIN.	X	—
VOLTAGE PROOF		650 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS					
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1 μs.	X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.	② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
ENVIRONMENTAL CHARACTERISTICS					
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 →5 TO 35 →+85→5 TO35°C TIME 30 →10TO15 →30 →10 TO 15min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		X	—
RESISTANCE TO SOLDERING HEAT		SOLDER TEMPERATURE, 260±5 °C, FOR.  IMMERSION,DURATION, 10s.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 230±5°C FOR INSERTION DURATION, 5s.	SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	X	—
REMARKS					
NOTE1 : INCLUDING THE TEMPERATURE RISE BY CURRENT. NOTE2 : NON-CONDENSING. NOTE3 : APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD,OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.					
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
	1		MI. SAKIMURA	HK. UMEHARA	10. 05. 24
Unless otherwise specified, refer to JIS C 5402.			APPROVED	KJ. KATAYOSE	05. 01. 05
			CHECKED	TY. OMA	05. 01. 05
			DESIGNED	TS. KUMAZAWA	05. 01. 05
			DRAWN	TS. KUMAZAWA	05. 01. 05
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-162343-10
	SPECIFICATION SHEET		PART NO.	DF1-*P-2. 5DS (05)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL541	 1/1